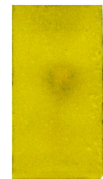


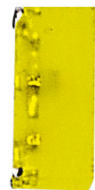
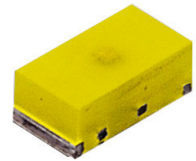
SpiceLED

Like spice, its diminutive size is a stark contrast to its standout performance in terms of brightness, durability and reliability. Despite being the smallest in size yet the SpiceLED packs a powerful performance and is a highly reliable design device. Its versatility enables its application in automotive appliances, key-pad illumination, hand-held devices such as PDAs, notebooks, compact back-lighting applications, consumer appliances, office equipment, audio and video equipment.



Features:

- > High brightness surface mount LED.
- > Super wide viewing angle of 160°.
- > Equivalent to 0603 package outline. Copper lead-frame construction.
- > Qualified according to JEDEC moisture sensitivity Level 2.
- > Compatible to IR reflow soldering.
- > Environmental friendly; RoHS compliance.
- > Compliance to automotive standard; AEC-Q101.
- > Superior corrosion resistant.



Applications:

- > Automotive: Interior applications, eg: switches, telematics, climate control system, dashboard, etc
- > Signage: full colour display video notice board, signage, special effect lighting.

Optical Characteristics at Tj=25°C

Part Ordering Number	Color	Viewing Angle°	Luminous Intensity @ IF = 5mA IV (mcd) <i>Appx. 1.1</i>		
			Min.	Typ.	Max.
● SSW-LLG-P2Q-F1H5-I5	White	160	56.0	90.0	112.5
SSW-LLG-QR1-F1H5-I5	White	160	71.5	112.5	140.0
● SSW-LLG-QR1-I1L5-I5	White	160	71.5	112.5	140.0
SSW-LLG-Q2R-I1L5-I5	White	160	90.0	140.0	180.0
● SSW-LLG-QR1-M1P5-I5	White	160	71.5	112.5	140.0
SSW-LLG-Q2R-M1P5-I5	White	160	90.0	140.0	180.0

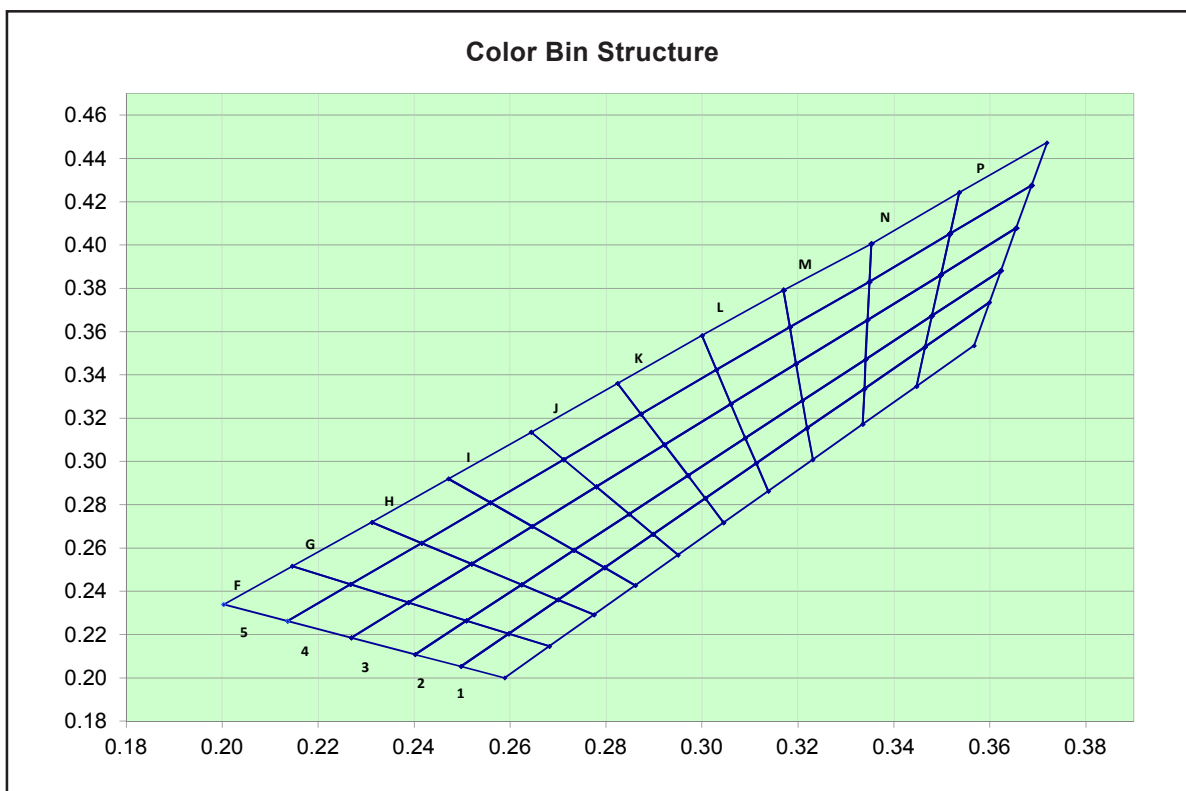
● Not for new design.

Part Number	Vf @ If = 5mA <i>Appx. 3.1</i>			Vr @ Ir = 10uA
	Min. (V)	Typ. (V)	Max. (V)	Min. (V)
SSW-LLG	2.6	2.9	3.2	5

Absolute Maximum Ratings

	Maximum Value	Unit
DC forward current	15	mA
Peak pulse current; (tp ≤ 10µs, Duty cycle = 0.1)	100	mA
Reverse voltage; Ir _{max} = 10µA	5	V
ESD threshold (HBM)	2000	V
LED junction temperature	110	°C
Operating temperature	-40 ... +100	°C
Storage temperature	-40 ... +100	°C
Power dissipation (at room temperature)	80	mW
Thermal resistance		
- Junction / ambient, R _{th JA}	590	K/W
- Junction / solder point, R _{th JS}	200	K/W
(Mounted on FR4 PCB; pad size ≥16mm ² per pad)		

Color Grouping *Appx. 2.1*



Bin		1	2	3	4
F1	Cx	0.2498	0.2589	0.2682	0.2597
	Cy	0.2053	0.2000	0.2146	0.2204
F2	Cx	0.2402	0.2498	0.2597	0.2509
	Cy	0.2108	0.2053	0.2204	0.2264
F3	Cx	0.2269	0.2388	0.2509	0.2402
	Cy	0.2185	0.2348	0.2264	0.2108
F4	Cx	0.2136	0.2267	0.2388	0.2269
	Cy	0.2262	0.2432	0.2348	0.2185
F5	Cx	0.2003	0.2146	0.2267	0.2136
	Cy	0.2339	0.2516	0.2432	0.2262
G1	Cx	0.2597	0.2682	0.2775	0.2700
	Cy	0.2204	0.2146	0.2292	0.2361
G2	Cx	0.2509	0.2597	0.2700	0.2624
	Cy	0.2264	0.2204	0.2361	0.2431
G3	Cx	0.2388	0.2509	0.2624	0.2520
	Cy	0.2348	0.2264	0.2431	0.2527
G4	Cx	0.2267	0.2416	0.2520	0.2388
	Cy	0.2432	0.2623	0.2527	0.2348
G5	Cx	0.2146	0.2312	0.2416	0.2267
	Cy	0.2516	0.2719	0.2623	0.2432

Bin		1	2	3	4
H1	Cx	0.2700	0.2775	0.2861	0.2797
	Cy	0.2361	0.2292	0.2427	0.2509
H2	Cx	0.2624	0.2700	0.2797	0.2733
	Cy	0.2431	0.2361	0.2509	0.2590
H3	Cx	0.2520	0.2624	0.2733	0.2646
	Cy	0.2527	0.2431	0.2590	0.2700
H4	Cx	0.2416	0.2559	0.2646	0.2520
	Cy	0.2623	0.2810	0.2700	0.2527
H5	Cx	0.2312	0.2472	0.2559	0.2416
	Cy	0.2719	0.2920	0.2810	0.2623
I1	Cx	0.2797	0.2861	0.2950	0.2898
	Cy	0.2509	0.2427	0.2568	0.2664
I2	Cx	0.2733	0.2797	0.2898	0.2848
	Cy	0.2590	0.2509	0.2664	0.2757
I3	Cx	0.2646	0.2733	0.2848	0.2780
	Cy	0.2700	0.2590	0.2757	0.2883
I4	Cx	0.2559	0.2712	0.2780	0.2646
	Cy	0.2810	0.3009	0.2883	0.2700
I5	Cx	0.2472	0.2644	0.2712	0.2559
	Cy	0.2920	0.3135	0.3009	0.2810
J1	Cx	0.2898	0.2950	0.3045	0.3007
	Cy	0.2664	0.2568	0.2717	0.2830
J2	Cx	0.2848	0.2898	0.3007	0.2971
	Cy	0.2757	0.2664	0.2830	0.2935
J3	Cx	0.2780	0.2848	0.2971	0.2922
	Cy	0.2883	0.2757	0.2935	0.3077
J4	Cx	0.2712	0.2873	0.2922	0.2780
	Cy	0.3009	0.3219	0.3077	0.2883
J5	Cx	0.2644	0.2824	0.2873	0.2712
	Cy	0.3135	0.3361	0.3219	0.3009
K1	Cx	0.3007	0.3045	0.3138	0.3113
	Cy	0.2830	0.2717	0.2862	0.2992
K2	Cx	0.2971	0.3007	0.3113	0.3090
	Cy	0.2935	0.2830	0.2992	0.3108
K3	Cx	0.2922	0.2971	0.3090	0.3060
	Cy	0.3077	0.2935	0.3108	0.3266
K4	Cx	0.2873	0.3030	0.3060	0.2922
	Cy	0.3219	0.3424	0.3266	0.3077
K5	Cx	0.2824	0.3000	0.3030	0.2873
	Cy	0.3361	0.3582	0.3424	0.3219
L1	Cx	0.3113	0.3138	0.3231	0.3219
	Cy	0.2992	0.2862	0.3008	0.3154
L2	Cx	0.3090	0.3113	0.3219	0.3209
	Cy	0.3108	0.2992	0.3154	0.3281
L3	Cx	0.3060	0.3090	0.3209	0.3196
	Cy	0.3266	0.3108	0.3281	0.3451
L4	Cx	0.3030	0.3183	0.3196	0.3060
	Cy	0.3424	0.3621	0.3451	0.3266
L5	Cx	0.3000	0.3170	0.3183	0.3030
	Cy	0.3582	0.3791	0.3621	0.3424

Bin		1	2	3	4
M1	Cx	0.3219	0.3231	0.3335	0.3339
	Cy	0.3154	0.3008	0.3172	0.3336
M2	Cx	0.3209	0.3219	0.3339	0.3341
	Cy	0.3281	0.3154	0.3336	0.3472
M3	Cx	0.3196	0.3209	0.3341	0.3345
	Cy	0.3451	0.3281	0.3472	0.3654
M4	Cx	0.3183	0.3349	0.3345	0.3196
	Cy	0.3621	0.3830	0.3654	0.3451
M5	Cx	0.3170	0.3353	0.3349	0.3183
	Cy	0.3791	0.4006	0.3830	0.3621
N1	Cx	0.3335	0.3339	0.3465	0.3447
	Cy	0.3172	0.3336	0.3530	0.3347
N2	Cx	0.3339	0.3341	0.3479	0.3465
	Cy	0.3336	0.3472	0.3673	0.3530
N3	Cx	0.3341	0.3345	0.3498	0.3479
	Cy	0.3472	0.3654	0.3863	0.3673
N4	Cx	0.3349	0.3517	0.3498	0.3345
	Cy	0.3830	0.4053	0.3863	0.3654
N5	Cx	0.3353	0.3536	0.3517	0.3349
	Cy	0.4006	0.4243	0.4053	0.3830
P1	Cx	0.3447	0.3465	0.3599	0.3567
	Cy	0.3347	0.3530	0.3735	0.3535
P2	Cx	0.3465	0.3479	0.3623	0.3599
	Cy	0.3530	0.3673	0.3882	0.3735
P3	Cx	0.3479	0.3498	0.3655	0.3623
	Cy	0.3673	0.3863	0.4079	0.3882
P4	Cx	0.3517	0.3687	0.3655	0.3498
	Cy	0.4053	0.4276	0.4079	0.3863
P5	Cx	0.3536	0.3719	0.3687	0.3517
	Cy	0.4243	0.4473	0.4276	0.4053

InGaN wavelength is very sensitive to drive current. Operating at lower current is not recommended and may yield unpredictable performance. Current pulsing should be used for dimming purposes.

Luminous Intensity Group at Tj=25°C

Brightness Group	Luminous Intensity IV (mcd) <small>Appx. 1.1</small>
P2	56.00 ... 71.50
Q1	71.50 ... 90.00
Q2	90.00 ... 112.50
R1	112.50 ... 140.00
R2	140.00 ... 180.00

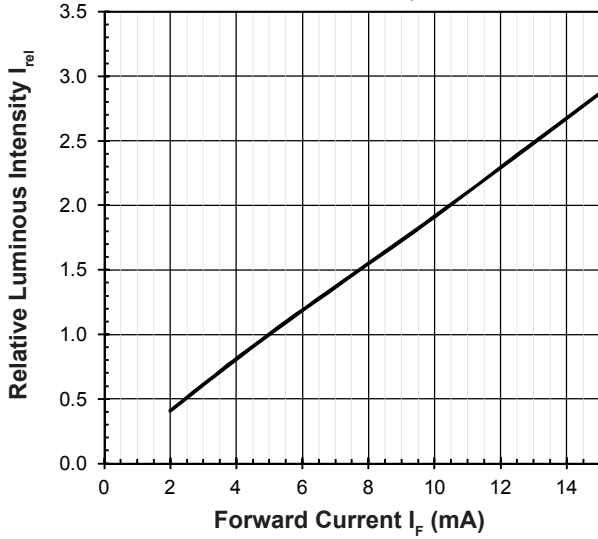
Vf Binning (Optional)

Vf Bin @ 5mA	Forward Voltage (V) <small>Appx. 3.1</small>
01	2.60 ... 2.70
02	2.70 ... 2.80
03	2.80 ... 2.90
04	2.90 ... 3.00
05	3.00 ... 3.10
06	3.10 ... 3.20
07	3.20 ... 3.30
08	3.30 ... 3.40

Please consult sales and marketing for special part number to incorporate Vf binning.

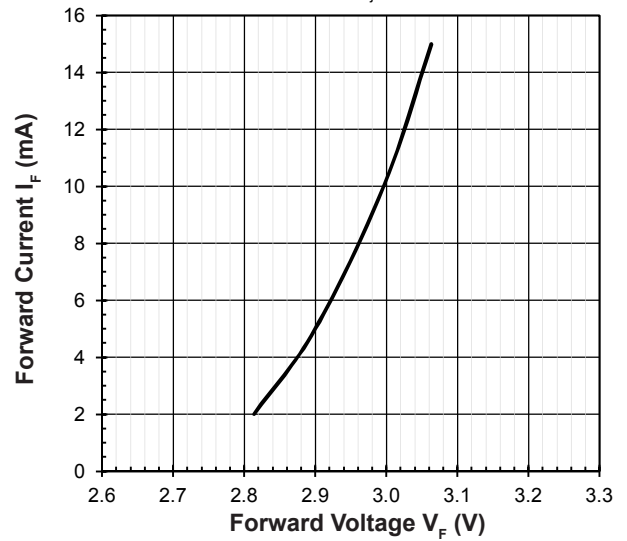
Relative Luminous Intensity Vs Forward Current

$I_v/I_v(5mA) = f(I_F); T_j = 25^\circ C$



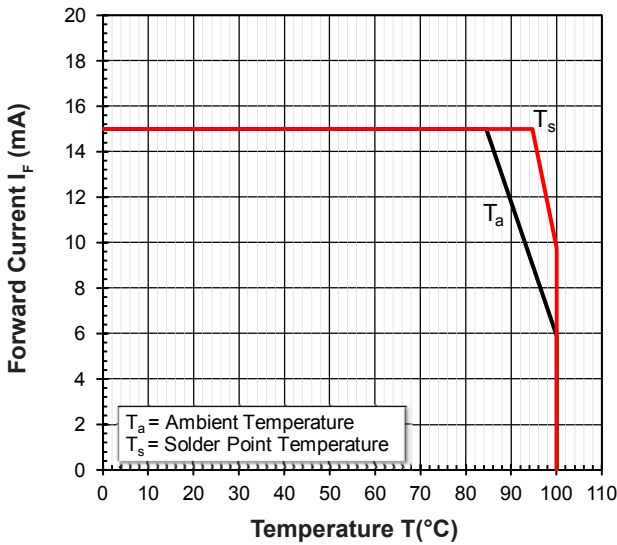
Forward Current Vs Forward Voltage

$I_F = f(V_F); T_j = 25^\circ C$



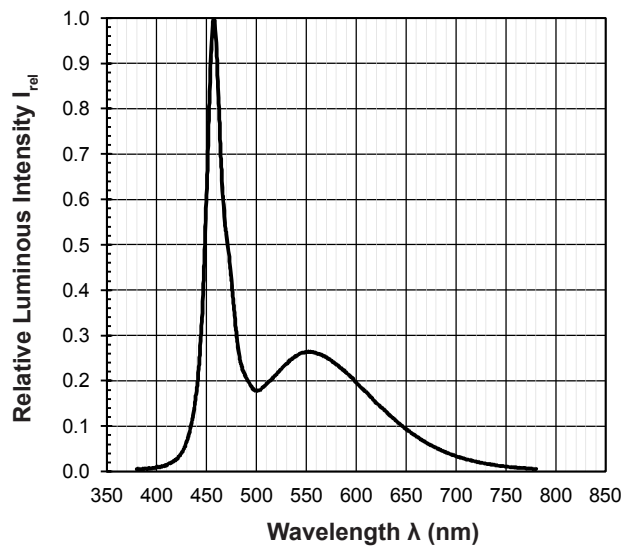
Maximum Current Vs Temperature

$I_F = f(T)$



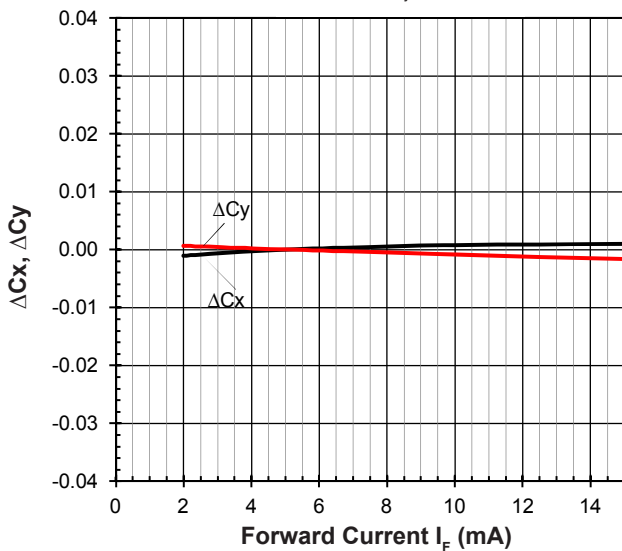
Relative Spectral Emission

$I_{rel} = f(\lambda); T_j = 25^\circ C; I_F = 5mA$



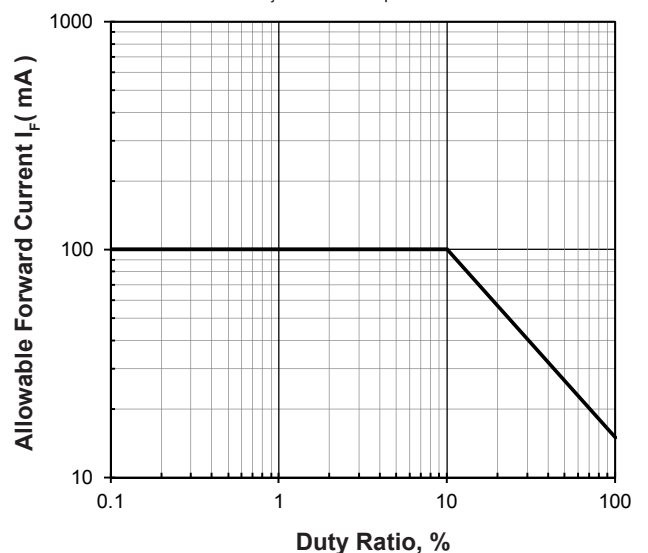
Chromaticity Coordinate Shift Vs Forward Current

$\Delta Cx, \Delta Cy = f(I_F); T_j = 25^\circ C$

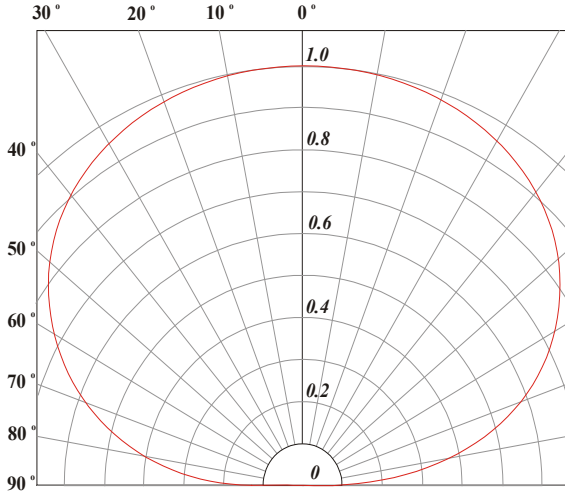


Allowable Forward Current Vs Duty Ratio

$(T_j = 25^\circ C; t_p \le 10\mu s)$

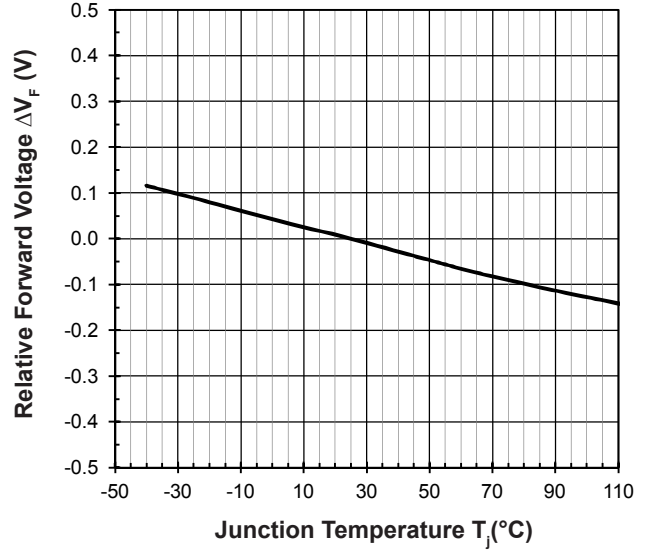


Radiation Pattern



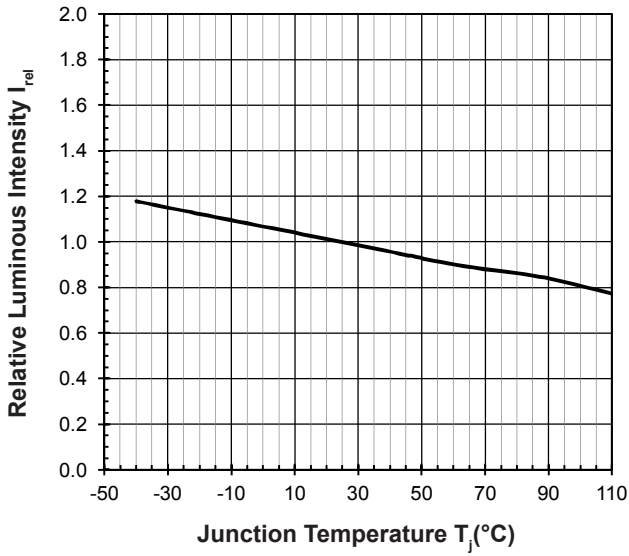
Relative Forward Voltage Vs Junction Temperature

$$\Delta V_F = V_F - V_F(25^\circ\text{C}) = f(T_j); I_F = 5\text{mA}$$



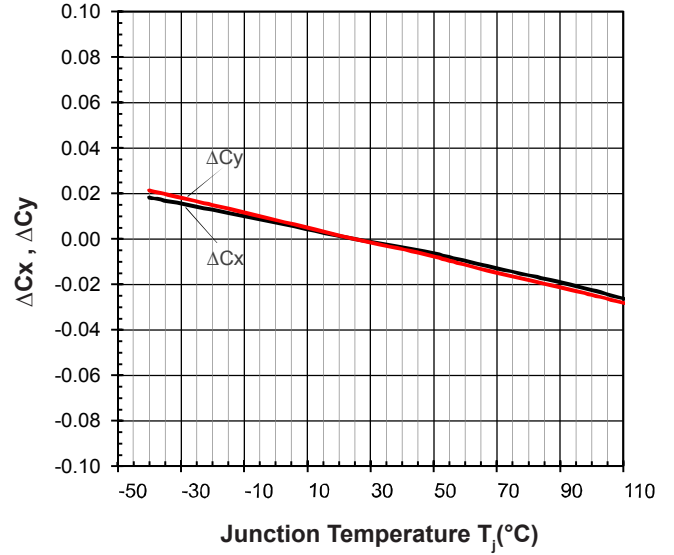
Relative Luminous Intensity Vs Junction Temperature

$$I_v/I_v(25^\circ\text{C}) = f(T_j); I_F = 5\text{mA}$$

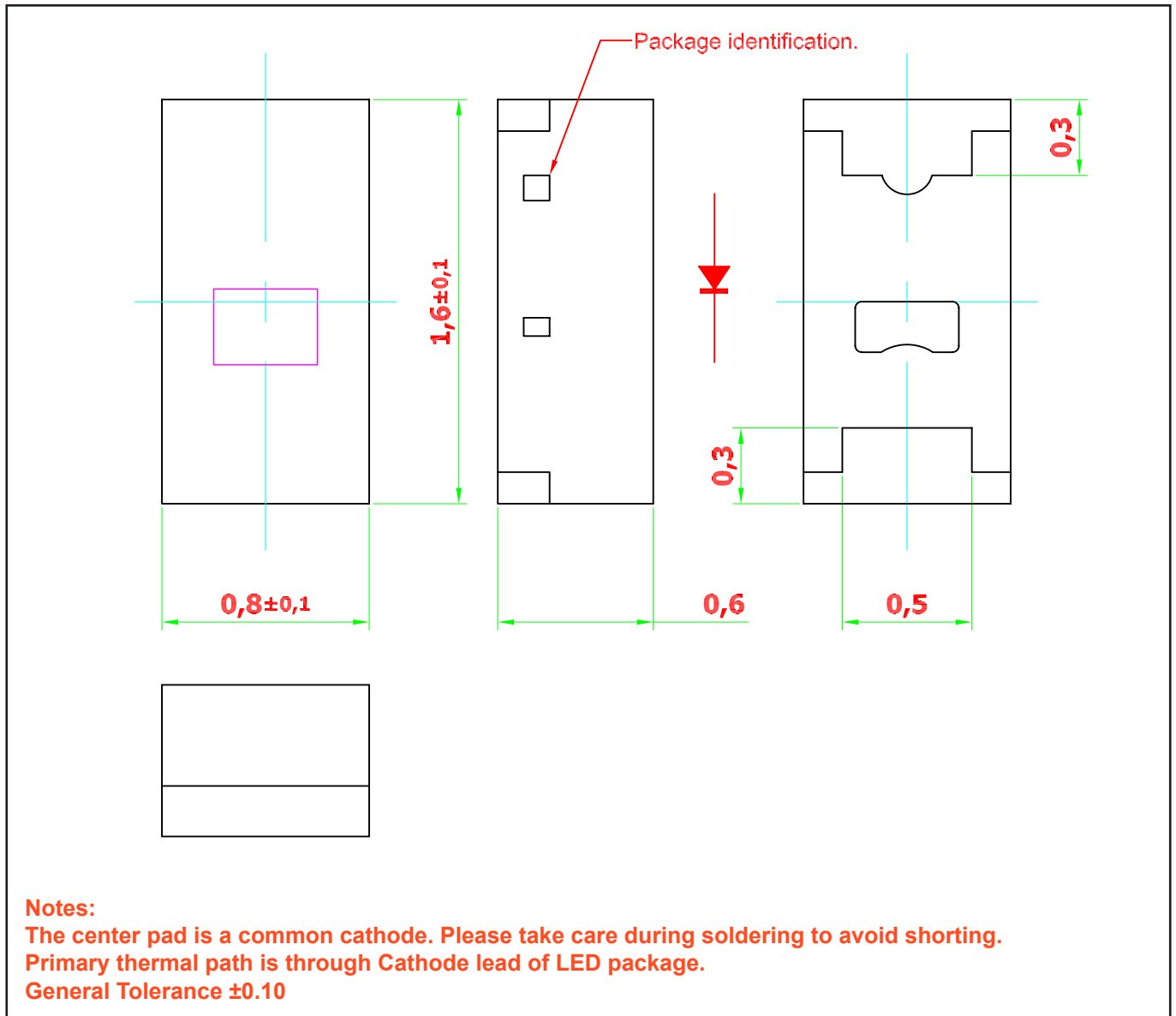


Chromaticity Coordinate Shift Vs Junction Temperature

$$\Delta Cx, \Delta Cy = f(T_j); I_F = 5\text{mA}$$



SpiceLED • InGaN White S-Spice : SSW-LLG-F1P5-I5 Package Outlines



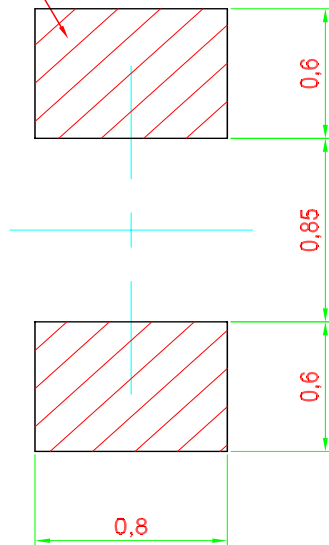
Material

Material	
Lead-frame	Cu Alloy With NiPdAu Plating
Package	High Temperature Resistant Epoxy Resin

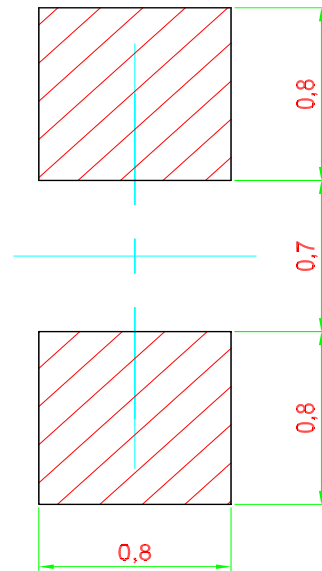
Note: product is Pb free

Recommended Solder Pad

Solder pad.

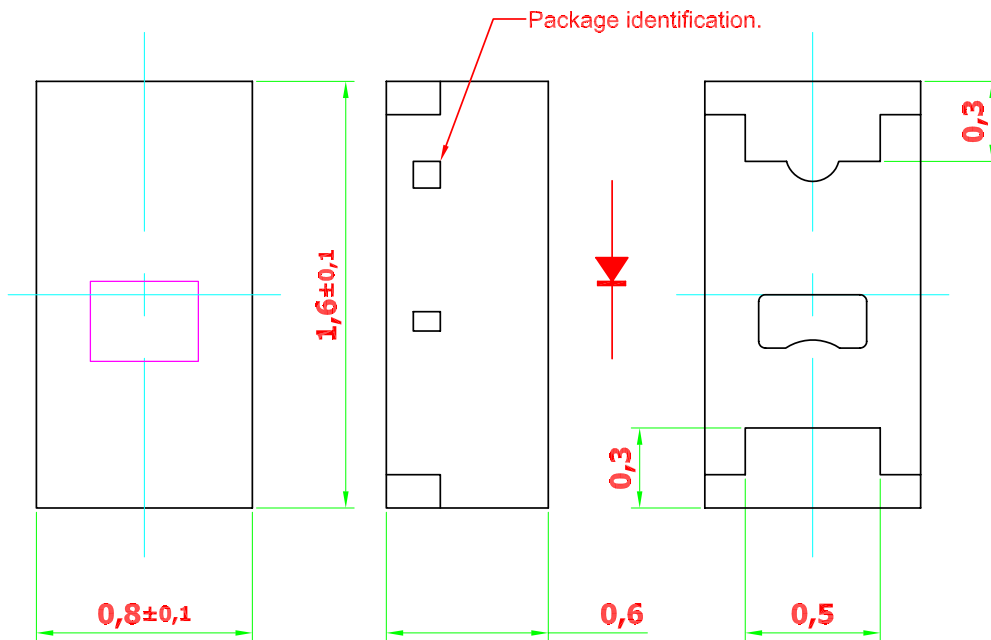


Recommended Solder-pad



Alternative Solder-pad
 Compatible to ChipLED 0603

Note: Component is based on a new package platform, which features "Bottom Only Terminations". Solder joints are only formed at the bottom of the component and solder fillet will not be observable as the sides of the component.

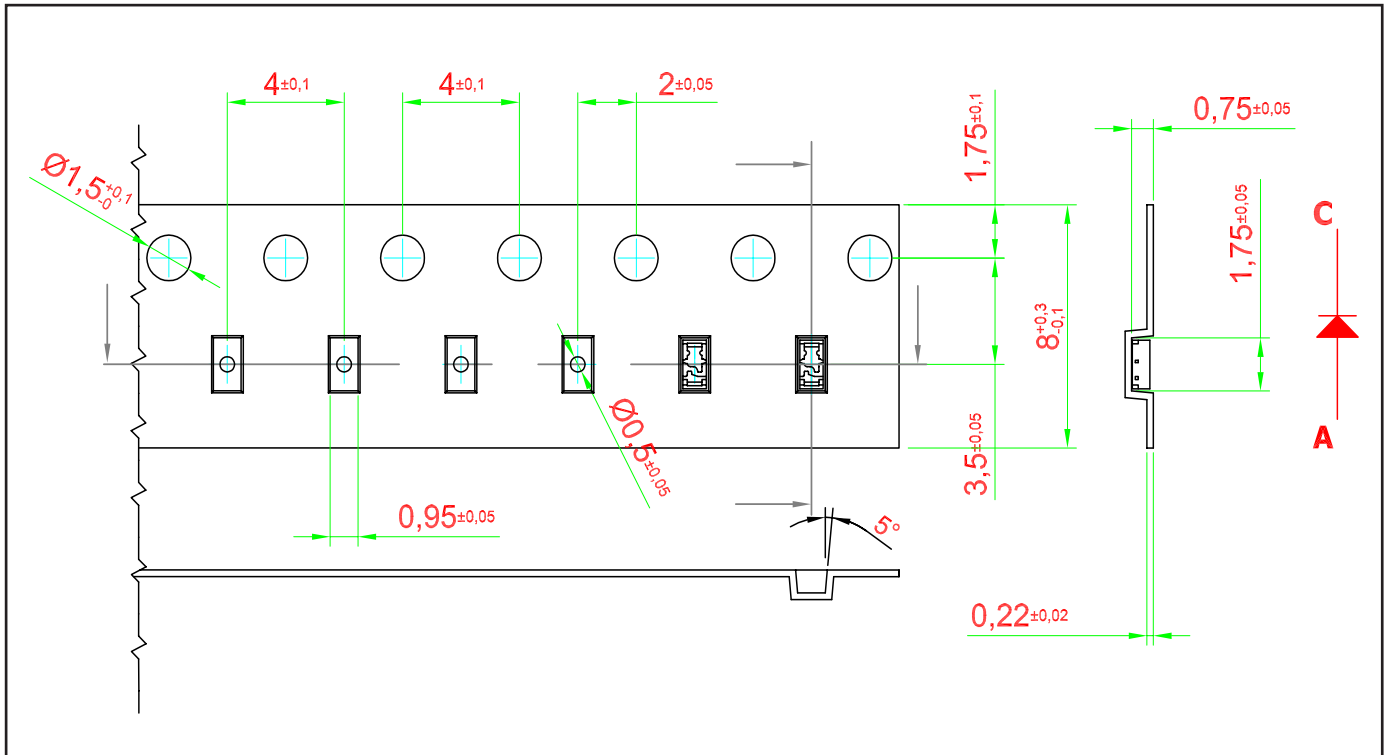


Surface are not intended for soldering

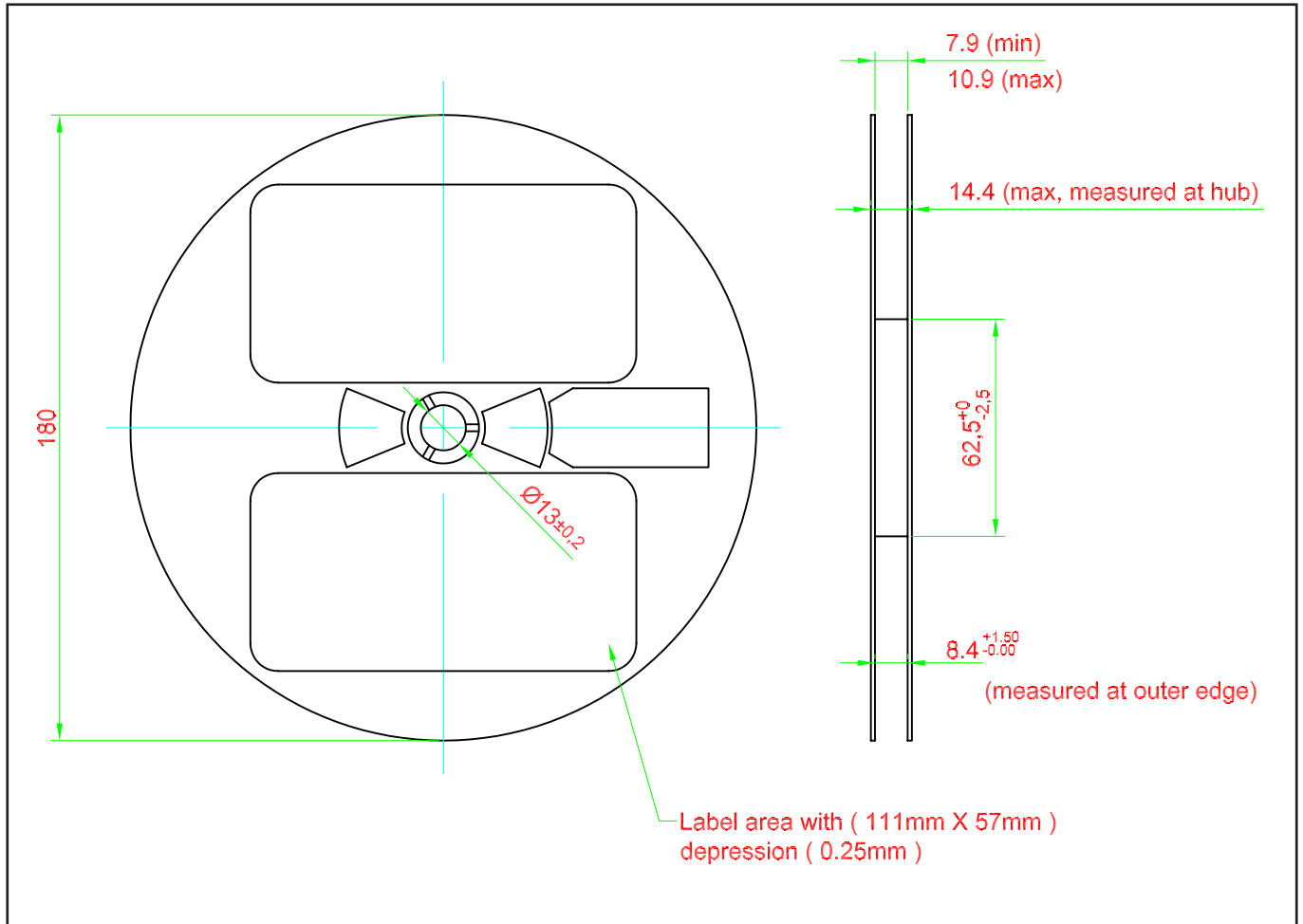
General Tolerances
± 0.10

Taping and orientation

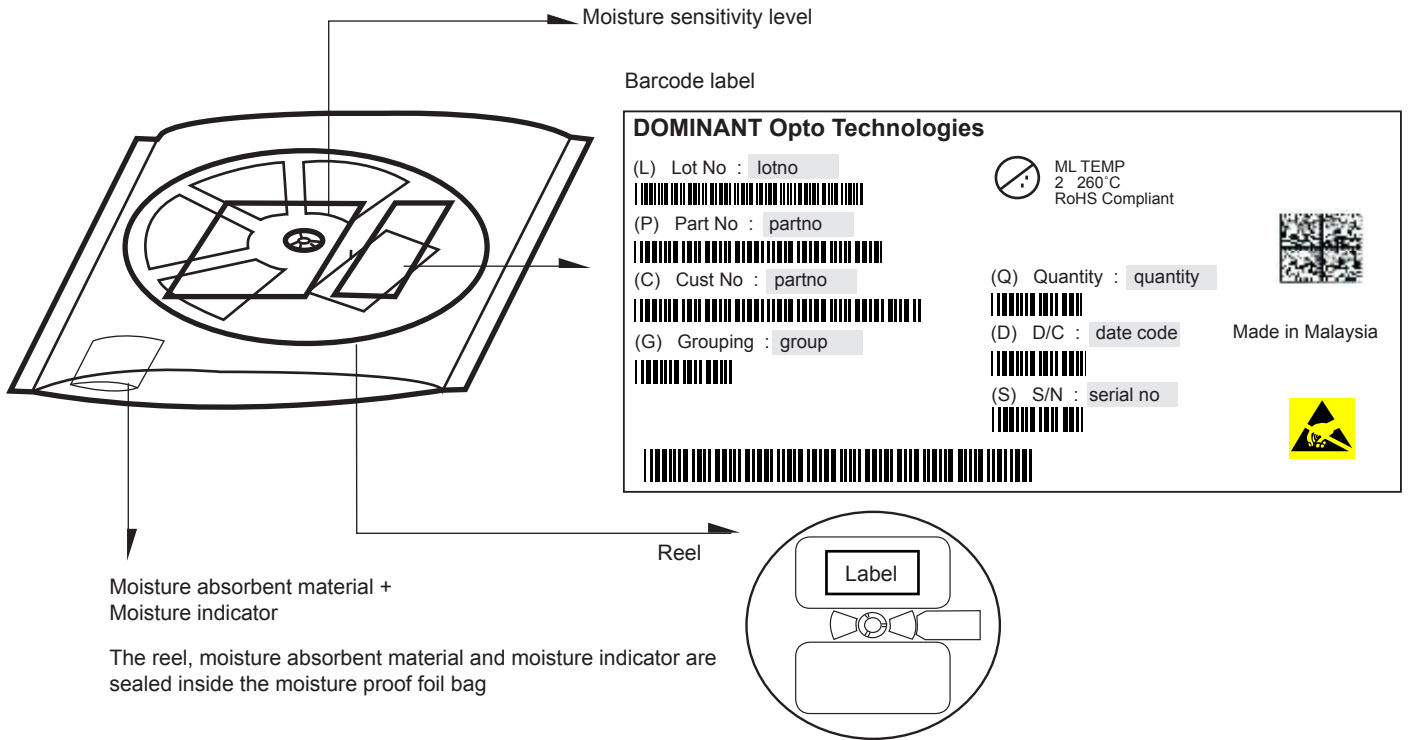
- Reels come in quantity of 3000 units.
- Reel diameter is 180 mm.



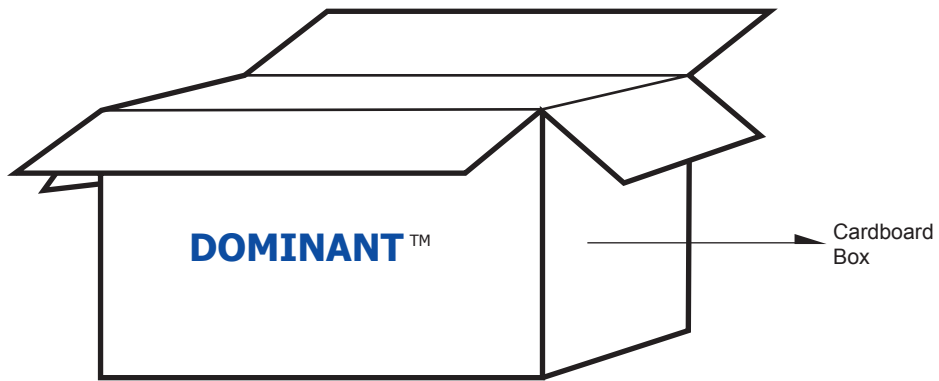
Packaging Specification



Packaging Specification



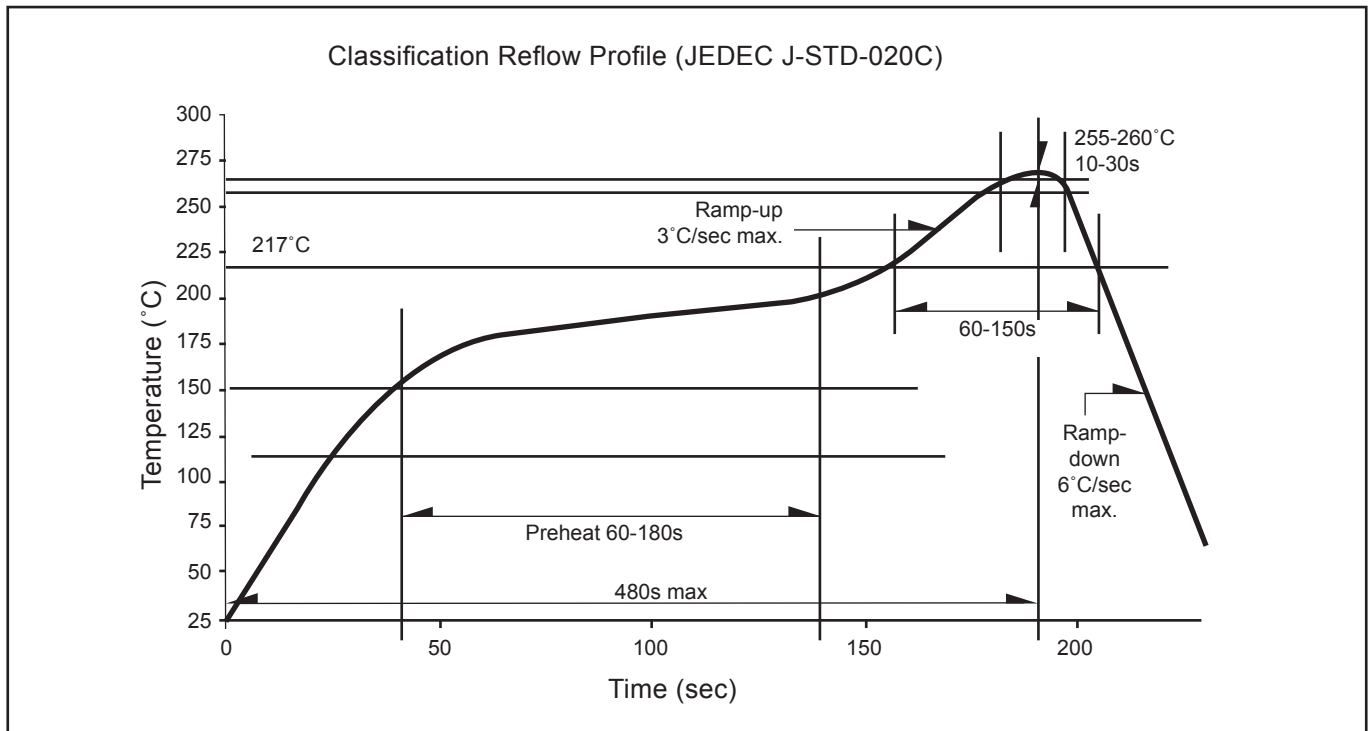
	Average 1pc SpiceLED	1 completed bag (3000pcs)
Weight (gram)	0.002	140 ± 10



For SpiceLED

Cardboard Box Size	Dimensions (mm)	Empty Box Weight (kg)	Reel / Box
Super Small	325 x 225 x 190	0.38	9 reels MAX
Small	325 x 225 x 280	0.54	15 reels MAX
Medium	570 x 440 x 230	1.46	60 reels MAX
Large	570 x 440 x 460	1.92	120 reels MAX

Recommended Pb-free Soldering Profile



Appendix

1) **Brightness:**

- 1.1 Luminous intensity is measured with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (according to GUM with a coverage factor of $k=3$).
- 1.2 Luminous flux is measured with an internal reproducibility of $\pm 8\%$ and an expanded uncertainty of $\pm 11\%$ (according to GUM with a coverage factor of $k=3$).

2) **Color:**

- 2.1 Chromaticity coordinate groups are measured with an internal reproducibility of ± 0.005 and an expanded uncertainty of ± 0.01 (accordingly to GUM with a coverage factor of $k=3$).
- 2.2 DOMINANT wavelength is measured with an internal reproducibility of $\pm 0.5\text{nm}$ and an expanded uncertainty of $\pm 1\text{nm}$ (accordingly to GUM with a coverage factor of $k=3$).

3) **Voltage:**

- 3.1 Forward Voltage, V_f is measured with an internal reproducibility of $\pm 0.05\text{V}$ and an expanded uncertainty of $\pm 0.1\text{V}$ (accordingly to GUM with a coverage factor of $k=3$).

Revision History

Page	Subjects	Date of Modification
-	Initial Release	23 Aug 2016
2, 7	Update DC forward current Update Graph	21 Mar 2017
2	Not for New Design: SSW-LLG-P2Q-F1H5-I5, SSW-LLG-QR1-I1L5-I5, SSW-LLG-QR1-M1P5-I5 Add New Partno: SSW-LLG-QR1-F1H5-I5, SSW-LLG-Q2R-I1L5-I5, SSW-LLG-Q2R-M1P5-I5	25 Aug 2017

NOTE

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